

■ Material Data Sheet

PKG TYPE	64-LQFP	Part NO.	W3100APB
Total amount [gram]	0.3312	Lead-free	Yes
Part Name	Substance name	Substance mass(g) of total	
Leadframe	Copper	0.0573	
	Nickel	0.0018	
	Others	0.0005	
Wire Bonding	Au	0.0017	
Molding	Silica	0.2088	
	Antimony Trioxide	0.0012	
	Halogen based flmae Retardant	0.0012	
	Halogenated polymer	0.0012	
	Others	0.0332	
Silicon Chip	Silicon	0.0176	
Adhesive	Epoxy	0.0014	
Sn alloy	Sn	0.0051	
	Bi	0.0002	